

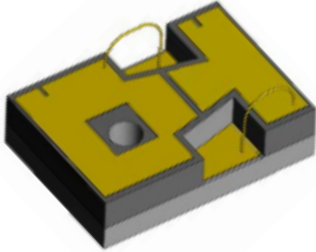
0.5mm Movement Free Space etMEMS™ Attenuator Chip/Sub-mount



(Protected by US patent 10752492B2)

DATASHEET

BUY NOW



The **etMEMS™** series of free space variable optic attenuator (FS-VOA) is based on a proprietary patent pending micro-electro-mechanical mechanism featuring exceptionally compact size with large shutter movement, simple construction, and easy direct drive. The **etMEMS™** series of FS-VOA is designed to block a collimated light beam completely $\leq 400\mu\text{m}$ in diameter and be operated in the air without the need for a hermetic seal and is fully compliant with the Telcordia 1209 and 1221 reliability standards. The device is ideally suited to be integrated into laser systems. The different movement FS-VOA chip up to $700\mu\text{m}$ is available.

Features

- Compact
- High Reliability
- Low IL, PDL, WDL & TDL
- Intrinsic tolerance to ESD

Applications

- Power Control
- Power Regulate
- Channel Balance
- Instrumentation

Specifications

Parameter	Min	Typical	Max	Unit
Attenuation Resolution		Continuous		
Shutter Movement		500		μm
Response Time		20	40	ms
Optical Power Handling		500		mW
Driving Voltage ^[1]		3.6	4.0	V
Device Resistance		90 ^[2]	120	Ohm
Power Consumption		210	250	mW
Resonant Frequency	200			Hz
Operating Temperature	-5		75	°C
Storage Temperature	-40		85	°C
Reliability	Telcordia 1209 and 1221			
Package Dimension	See drawing below			

Note:

- [1]. For full dynamic range.
- [2]. At voltage 3.6V.

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Rev 02/06/24

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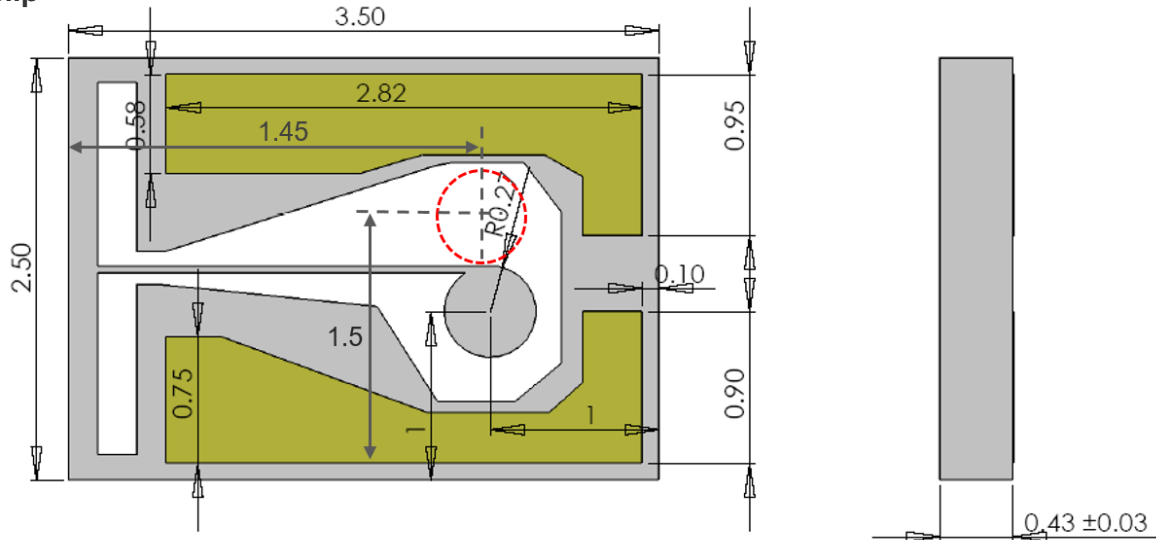


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Mechanical Footprint Dimensions (mm)

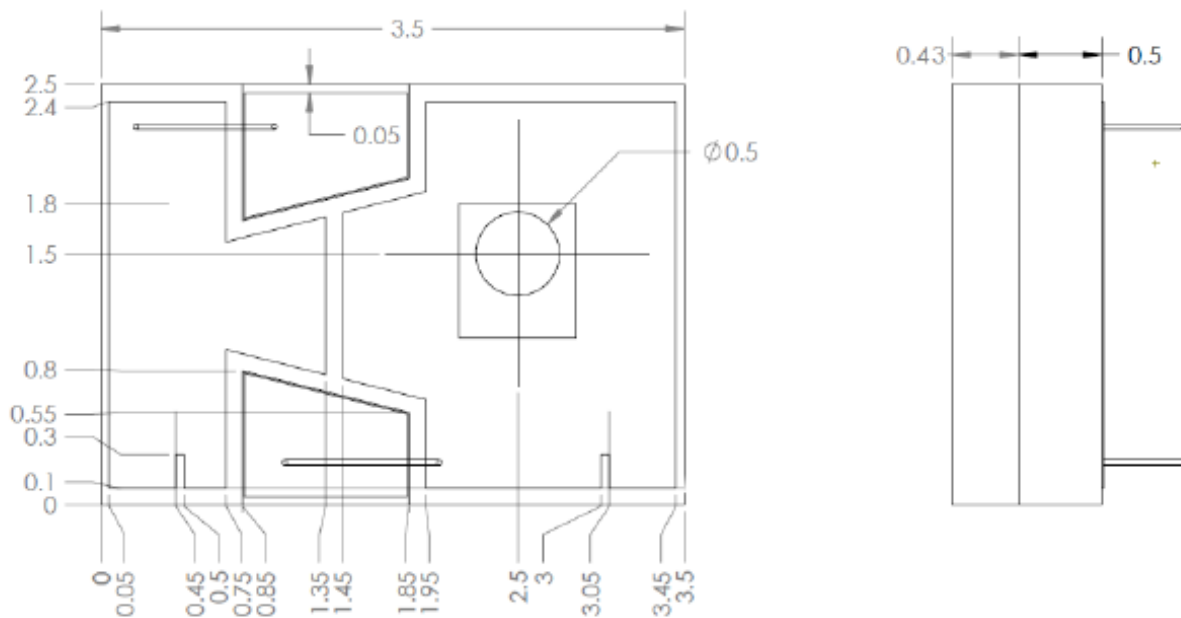
Bare Chip



NOTE:

- The red dash-line represents the shutter's position under $\sim 4.0V$.

Chip on Sub-mount: Standard package with $\phi 500\mu m$ aperture (No Pin, normal bright configuration)



*Product dimensions may change without notice. This is sometimes required for non-standard specifications.

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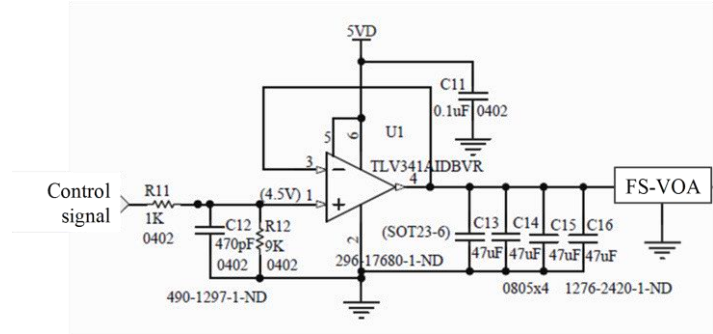
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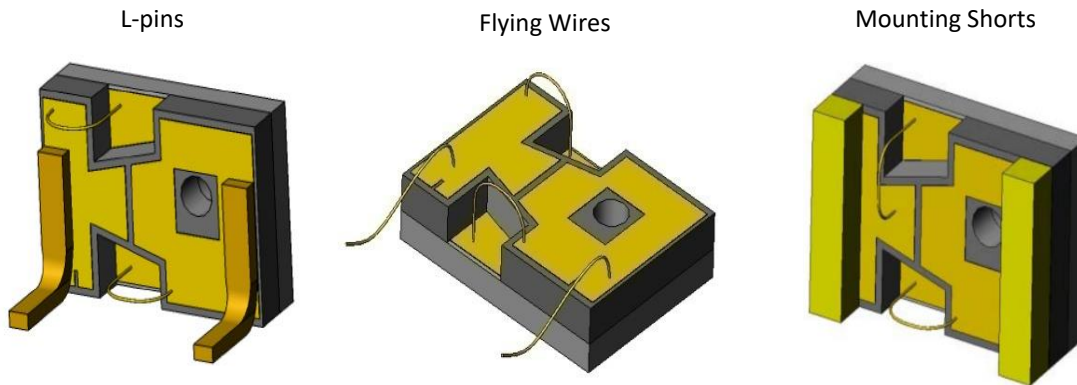
Electronic Driving Instruction

NOTES:

- Resistive without polarity
- Applying >4.5V will burn the chip
- Two pads are for applying a voltage
- Reference driving circuit on the right



Electronic Pin Option for sub-mount



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Ordering Information

Prefix	Shutter size	Wavelength	VOA Type	Shutter Surface	Chip Package	Chip Design	Electric connection ^[2]	Package
FSVOA-	∅500um = 50 ^[1]	Broadband = 1	Standard = 1 Special = 0	Gold = 1	Bare = 2	Standard = 1 Special = 0	No PIN = 0 L Pin = 1 Flying Wires = 2 Mounting shorts = 3	Bare chip = C Sub-mount = 1

[1]. Different shutter size is available, please check another size FS-VOA chip datasheet.

[2]. PIN selection is only applicable to the chip on sub-mount

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Shutter Performance (Typical)

